

L Number	Hits	Search Text	DB	Time stamp
-	1	Transfer adj patterned adj metal adj cold-welding	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:15
-	2	(("5294870") or ("4769292")).PN.	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:18
-	1	("5925259").PN.	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:19
-	7	("2897066"   "3647508"   "3716911"   "4021279"   "5512131"   "5725788"   "5772905").PN.	USPAT	2004/03/10 18:21
-	11	5925259.URPN.	USPAT	2004/03/10 18:23
-	5	("5641611"   "5707745"   "5925259"   "6013538"   "6027630").PN.	USPAT	2004/03/10 18:29
-	6	("5641611"   "5707745"   "5925259"   "5998803"   "6013538"   "6027630").PN.	USPAT	2004/03/10 18:31
-	5247	(pattern\$3) and substrate and (thin adj film) and (press\$3) and die	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:38
-	3316	(pattern\$3) same substrate and (thin adj film) and (press\$3) and die	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:38
-	990	(pattern\$3) same substrate same (thin adj film) and (press\$3) and die	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:38
-	5	(pattern\$3) same substrate same (thin adj film) and (press\$3) and die and (cold adj weld\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:41
-	194	(pattern\$3) same substrate same (thin adj film) same die and (press\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:42
-	18	5259926.URPN.	USPAT	2004/03/10 18:47
-	9	("5641611"   "5707745"   "5925259"   "5998803"   "6013538"   "6027630"   "6190940"   "6214631"   "6504096").PN.	USPAT	2004/03/11 09:38
-	6	("5641611"   "5707745"   "5925259"   "5998803"   "6013538"   "6027630").PN.	USPAT	2004/03/11 09:42
-	1	6468819.URPN.	USPAT	2004/03/11 09:42
-	5	("5641611"   "5707745"   "5925259"   "6013538"   "6027630").PN.	USPAT	2004/03/11 09:43
-	2	6294398.URPN.	USPAT	2004/03/11 09:43
-	434	(pattern\$3) same substrate same (electrode or (thin adj film)) same die and (press\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:00
-	325	(pattern\$3) same substrate same (electrode or (thin adj film)) same die and (press\$3) and remov\$3	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:01
-	128	(pattern\$3) same substrate same (electrode or (thin adj film)) same die and (press\$3) and remov\$3 same die	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:01
-	85	(pattern\$3) same substrate same (electrode or (thin adj film)) same die and (press\$3 same die) and (remov\$3 same die)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:43
-	20	5900160.URPN.	USPAT	2004/03/11 10:12

	35	("Re33581"   "2905539"   "3497377"   "3641354"   "3716359"   "4011009"   "4173075"   "4274706"   "4325779"   "4330175"   "4382657"   "4477158"   "4512848"   "4528260"   "4582566"   "4587213"   "4690715"   "4728591"   "4731155"   "4802951"   "4818336"   "4842633"   "4897325"   "4999489"   "5018829"   "5020879"   "5032216"   "5079600"   "5143854"   "5202227"   "5255273"   "5259926"   "5294369"   "5315436"   "5512131").PN.	USPAT	2004/03/11 10:23
	1	("5512131").PN.	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:33
	37	(pattern\$3) same substrate same (electrode or (thin adj film)) same stamp\$3 and (remov\$3 same stamp)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:55
	596	(die or stamp) and (cold adj weld\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:56
	94	((die or stamp) same (cold adj weld\$3)) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:56
	90	((die or stamp) same (cold adj weld\$3)) and substrate and (film or layer)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:57
	64	((die or stamp) same (cold adj weld\$3)) and substrate and (film or layer) and remov\$3	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:57
	50	((die or stamp) same (cold adj weld\$3)) and substrate and (film or layer) and (remov\$3 same (die or stamp))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:58
	228	(die or stamp) same (cold adj weld\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 11:54
	6	("5772905"   "5814885"   "5925259"   "6027630"   "6274508"   "6281038").PN.	USPAT	2004/03/11 11:27
	35	("Re33581"   "2905539"   "3497377"   "3641354"   "3716359"   "4011009"   "4173075"   "4274706"   "4325779"   "4330175"   "4382657"   "4477158"   "4512848"   "4528260"   "4582566"   "4587213"   "4690715"   "4728591"   "4731155"   "4802951"   "4818336"   "4842633"   "4897325"   "4999489"   "5018829"   "5020879"   "5032216"   "5079600"   "5143854"   "5202227"   "5255273"   "5259926"   "5294369"   "5315436"   "5512131").PN.	USPAT	2004/03/11 11:48
	598	(die or stamp or (forming adj member)) and (cold adj weld\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 11:55
	229	(die or stamp or (forming adj member)) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 11:55
	79	(die or stamp or (forming adj member)) and (cold adj weld\$3) and substrate and ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 11:58
	6	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion)) and (cold adj weld\$3) and substrate and ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:00
	6	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion)) and (cold adj weld\$3) and substrate and ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:03

	6	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:02
	20	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) or indentation) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:02
	1746	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) or indentation) and substrate and ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:04
	711	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) or indentation) and substrate with ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:04
	99	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) or indentation) and substrate with ((metal or conduct\$3) adj (film or layer)) and ((press\$3 or forc@3) with (die or stamp or (forming adj member)))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:06
	9	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) or indentation) and substrate with ((metal or conduct\$3) adj (film or layer)) and ((press\$3 or forc@3) with (die or stamp or (forming adj member))) and ((releas\$3 or remov@3) with (die or stamp or (forming adj member)))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:06
	1	("5707745").PN.	USPAT; US-PGPUB; IBM_TDB	2004/03/11 16:26
	130	heterostructure same polymer	USPAT; US-PGPUB; IBM_TDB	2004/03/11 16:26
	88	heterostructure with polymer	USPAT; US-PGPUB; IBM_TDB	2004/03/11 16:26
	5	heterostructure near polymer	USPAT; US-PGPUB; IBM_TDB	2004/03/11 16:26
	3	(29/846,847).ccls. and (die or stamp or (forming adj member)) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 17:55
	4	(438/22,23).ccls. and (die or stamp or (forming adj member)) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 17:55
	1	(257/79,88).ccls. and (die or stamp or (forming adj member)) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 17:56
	112	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) and substrate and ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 17:57
	61	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) and substrate and ((metal or conduct\$3) adj (film or layer)) and (die or stamp or (forming adj member)) with press\$3	USPAT; US-PGPUB; IBM_TDB	2004/03/11 17:59

-	23	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion)) and substrate and ((metal or conduct\$3) adj (film or layer)) and ((die or stamp or (forming adj member)) with press\$3) and ((die or stamp or (forming adj member)) with (remov\$3 or releas\$3))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 18:00
-	1	("6214631").PN.	USPAT; US-PGPUB; IBM_TDB	2004/06/18 08:29
-	45	(burrows-paul-e).in.	USPAT; US-PGPUB; IBM_TDB	2004/06/21 09:32
-	25	(burrows-paul-e).in. and pattern\$3	USPAT; US-PGPUB; IBM_TDB	2004/06/21 09:33
-	22	(burrows-paul-e).in. and pattern\$3 and metal	USPAT; US-PGPUB; IBM_TDB	2004/06/21 09:33
-	4	(burrows-paul-e).in. and pattern\$3 and metal and die	USPAT; US-PGPUB; IBM_TDB	2004/06/21 09:33